設備名稱: 充電基座 Equipment name 型號(型式): MB4-BAT-SCN02/MB12-BAT-SCN02 Type designation (Type) 限用物質及其化學符號 Restricted substances and its chemical symbols 六價鉻 多溴聯苯 多溴二苯醚 單元Unit 鉛Lead 汞Mercury 鎘Cadmium Hexavalent Polybrominated Polybrominated chromium biphenyls diphenyl ethers (Pb) (Cd) (Hg) (Cr+6) (PBB) (PBDE)  $\bigcirc$  $\bigcirc$  $\bigcirc$  $\bigcirc$  $\bigcirc$ 電路板 外殼  $\bigcirc$  $\bigcirc$ 電源 連線

備考1. "超出0.1 wt %"及 "超出0.01 wt %" 係指限用物質之百分比含量超出百分比含量基準值。

 $\bigcirc$ 

 $\bigcirc$ 

 $\bigcirc$ 

 $\bigcirc$ 

Note 1: "Exceeding 0.1 wt %" and "exceeding 0.01 wt %" indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

\*○″係指該項限用物質之百分比含量未超出百分比含量基準值。

 $\bigcirc$ 

Note 2: "0" indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. °-″ 係指該項限用物質為排除項目。

 $\bigcirc$ 

Note 3: The "-" indicates that the restricted substance corresponds to the exemption.